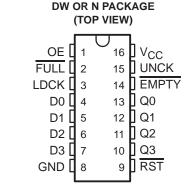
- Independent Asynchronous Inputs and Outputs
- 16 Words by 4 Bits
- Data Rates up to 40 MHz
- Fall-Through Time 14 ns Typical
- 3-State Outputs
- Package Options Include Plastic Small-Outline Package (DW), Plastic Chip Carriers (FN), and Standard Plastic 300-mil DIPs (N)

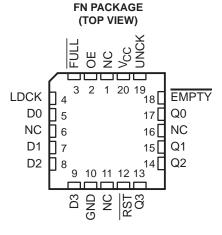
description

This 64-bit memory features high speed and fast fall-through times. It is organized as 16 words by 4 bits.

A first-in, first-out (FIFO) memory is a storage device that allows data to be written into and read from its array at independent data rates. This FIFO is designed to process data at rates up to 40 MHz in a bit-parallel format, word by word.

Data is written into memory on a low-to-high transition at the load-clock (LDCK) input and is read out on a low-to-high transition at the unload-clock (UNCK) input. The memory is full when the number of words clocked in exceeds by 16 the number of words clocked out. When the memory is full, LDCK signals have no effect on the data residing in memory. When the memory is empty, UNCK signals have no effect.





NC - No internal connection

Status of the FIFO memory is monitored by the FULL and EMPTY output flags. The FULL output is low when the memory is full and high when it is not full. The EMPTY output is low when the memory is empty and high when it is not empty.

A low level on the reset (\overline{RST}) input resets the internal stack-control pointers and also sets \overline{EMPTY} low and sets \overline{FULL} high. The Q outputs are not reset to any specific logic level. The first low-to-high transition on LDCK, after either a \overline{RST} pulse or from an empty condition, causes \overline{EMPTY} to go high and the data to appear on the Q outputs. It is important to note that the first word does not have to be unloaded. Data outputs are noninverting with respect to the data inputs and are at high impedance when the output-enable (OE) input is low. OE does not affect the \overline{FULL} or \overline{EMPTY} output flags. Cascading is easily accomplished in the word-width direction but is not possible in the word-depth direction.

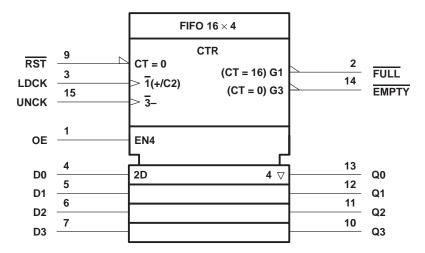
The SN74ALS232B is characterized for operation from 0°C to 70°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



logic symbol†



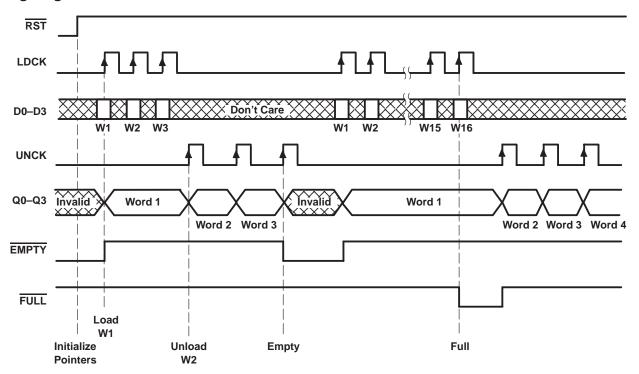
[†] This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12. The symbol is functionally accurate but does not show the details of implementation; for these, see the logic diagram. The symbol represents the memory as if it were controlled by a single counter whose content is the number of words stored at the time. Output data is invalid when the counter content (CT) is 0. Pin numbers shown are for the DW and N packages.



logic diagram (positive logic) Ring Counter 2 CTR **DIV 16** 4 5 6 8 10 Write Write 11 Address 12 13 14 **CT** = 1 15 S 16 16 Ring Counter 2 **CTR** 3 **DIV 16** 4 5 6 7 8 9 10 RST 9 Read 11 12 Address **RAM 16 × 4** 13 14 **CT** = 1 15 16 16 16 2A 1/16 13 1A, 3D Q0 12 D1 Q1 6 11 D2 Q2 10 D3 -Q3 16 **16** COMP P = QР **EMPTY** S P= Q+1 Q - FULL P = Q - 1R

Pin numbers shown are for the DW and N packages.

timing diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		\dots -0.5 V to 7 V
Input voltage range, V _I		\dots -0.5 V to 7 V
Voltage range applied to a disabled 3-state out	put	–0.5 V to 5.5 V
Package thermal impedance, θ _{JA} (see Note 2):	: DW package	105°C/W
	FN package	83°C/W
	N package	78°C/W
Storage temperature range, T _{stg}		. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the "recommended operating conditions" section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to GND.
 - 2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



SCAS251B - FEBRUARY 1989 - REVISED APRIL 1998

recommended operating conditions (see Note 3)

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage	2			V	
V _{IL}	Low-level input voltage				0.8	V
lau	High-level output current	Q outputs			-2.6	mA
ЮН	nigir-level output current	FULL, EMPTY			-0.4	IIIA
la.	Low-level output current	Q outputs		2		mA
lor	Low-level output current			8	IIIA	
TA	Operating free-air temperature	0		70	°C	

NOTE 3: To ensure proper operation of this high-speed FIFO device, it is necessary to provide a clean signal to the LDCK and UNCK clock inputs. Any excessive noise or glitching on the clock inputs that violates limits for maximum V_{IL}, minimum V_{IH}, or minimum pulse duration can cause a false clock or improper operation of the internal read and write pointers.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST	TEST CONDITIONS				
VIK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.2	V
V	Q outputs	V _{CC} = 4.5 V,	$I_{OH} = -2.6 \text{ mA}$	2.4	3.2		٧
VOH	FULL, EMPTY	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V
	Q outputs	V00 - 4 5 V	I _{OL} = 12 mA	(0.25	0.4	
\ \/a.	Qoulpuis	V _{CC} = 4.5 V	$I_{OL} = 24 \text{ mA}$	(0.35	0.5	V
VOL	FULL, EMPTY	V00 - 45 V	$I_{OL} = 4 \text{ mA}$	(0.25	0.4	V
		VCC = 4.5 V	$I_{OL} = 8 \text{ mA}$	(0.35	0.5	
lozh		V _{CC} = 5.5 V,	V _O = 2.7 V			20	μΑ
lozL		V _{CC} = 5.5 V,	V _O = 0.4 V			-20	μΑ
II		$V_{CC} = 5.5 V,$	V _I = 7 V			0.1	mA
lн		V _{CC} = 5.5 V,	V _I = 2.7 V			20	μΑ
Ι _Ι Γ		V _{CC} = 5.5 V,	V _I = 0.4 V			-0.2	mA
lo [‡]		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA
Icc		V _{CC} = 5.5 V			80	125	mA

 $[\]uparrow$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, IOS.

SN74ALS232B 16×4 ASYNCHRONOUS FIRST-IN, FIRST-OUT MEMORY

SCAS251B - FEBRUARY 1989 - REVISED APRIL 1998

timing requirements over recommended operating free-air temperature range (see Figure 1)

			MIN	NOM	MAX	UNIT
4 +	Clock frequency				40	MHz
f _{clock} †	Clock frequency	UNCK			40	IVII IZ
		RST low	18			
	Pulse duration	LDCK low	15			
t _W		LDCK high	10			ns
		UNCK low	15			
		UNCK high	10			
	Cotup time	Data before LDCK↑	8			ns
t _{su}	Setup time	LDCK inactive before RST↑	5			115
4.	Hold time	Data after LDCK↑	5			no
t _h	noia time	LDCK inactive after RST↑	5			ns

[†] The maximum possible clock frequency is 40 MHz. The maximum clock frequency when using a 50% duty cycle is 33.3 MHz.

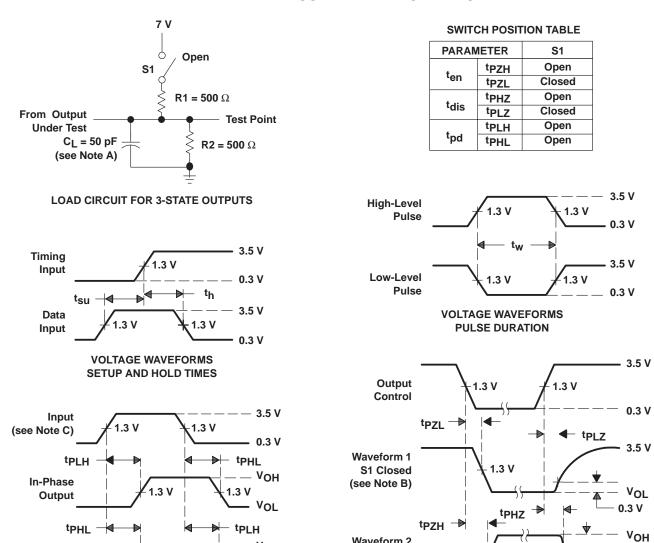
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN TYP‡	MAX	MIN	MAX	UNIT
f _{max}	LDCK, UNCK		50		40		MHz
4 .	LDCK↑	Any 0	14	23	6	30	
^t pd	UNCK↑	- Any Q	15	23	6	30	ns
^t PLH	LDCK↑	EMPTY	13	20	5	25	ns
	UNCK↑	EMPTY	15	22	6	27	
t _{PHL}	RST↓	EMPTY	15	21	5	26	ns
	LDCK↑	FULL	15	22	6	27	
4	UNCK↑	<u></u>	13	20	5	25	
^t PLH	RST↓	FULL	16	23	7	28	ns
t _{en}	OE↑	Q	5	12	1	14	ns
t _{dis}	OE↓	Q	5	12	1	16	ns

[‡] Typical values at $V_{CC} - 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

VOLTAGE WAVEFORMS

PROPAGATION DELAY TIMES

Out-of-Phase

Output

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

Waveform 2

(see Note B)

S1 Open

1.3 V

VOLTAGE WAVEFORMS

ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_0 = 50 \Omega$, $t_f \leq$ 2 ns, $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.

۷он

VOL

Figure 1. Load Circuit and Voltage Waveforms

0.3 V

0 V



www.ti.com 22-Mar-2025

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN74ALS232BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS232BN	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 9-Feb-2024

TUBE



*All dimensions are nominal

Device	Package Name Package Type		Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)	
SN74ALS232BN	N	PDIP	16	25	506	13.97	11230	4.32	

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025. Texas Instruments Incorporated